

Product Summary

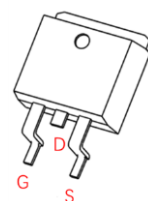
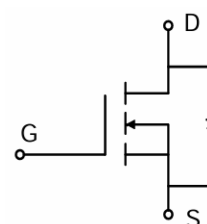
$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
60V	2.8mΩ@10V	200A
	4.5mΩ@4.5V	

Feature

- Split Gate Trench Technology
- Low $R_{DS(ON)}$
- Low Gate Charge
- Low Gate Resistance
- 100% UIS Tested

Application

- Power Management
- Load Switching
- Motor Driving
- High frequency switching, synchronous rectification

TO-263-2L

Schematic diagram

Package Marking and Ordering Information

Part Number	Package	Marking	Packing	Reel Size	Tape Width	Qty
GPT030N06LTH	TO-263-2L	T030N06L	Reel & Tape	330mm	24mm	800pcs

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Parameter		Symbol	Value	Unit
Drain-Source Voltage		V_{DS}	60	V
Gate-Source Voltage		V_{GS}	±20	V
Continuous Drain Current ¹	$T_C = 25^\circ\text{C}$	I_D	200	A
	$T_C = 100^\circ\text{C}$		126	
Pulsed Drain Current ²		I_{DM}	800	A
Single Pulsed Avalanche Current ³		I_{AS}	42	A
Single Pulsed Avalanche Energy ³		E_{AS}	441	mJ
Power Dissipation ⁵	$T_C = 25^\circ\text{C}$	P_D	178.5	W
Thermal Resistance from Junction to Ambient ⁶		$R_{\theta JA}$	35	°C/W
Thermal Resistance from Junction to Case		$R_{\theta JC}$	0.7	°C/W
Junction Temperature		T_J	150	°C
Storage Temperature		T_{STG}	-55~ +150	°C

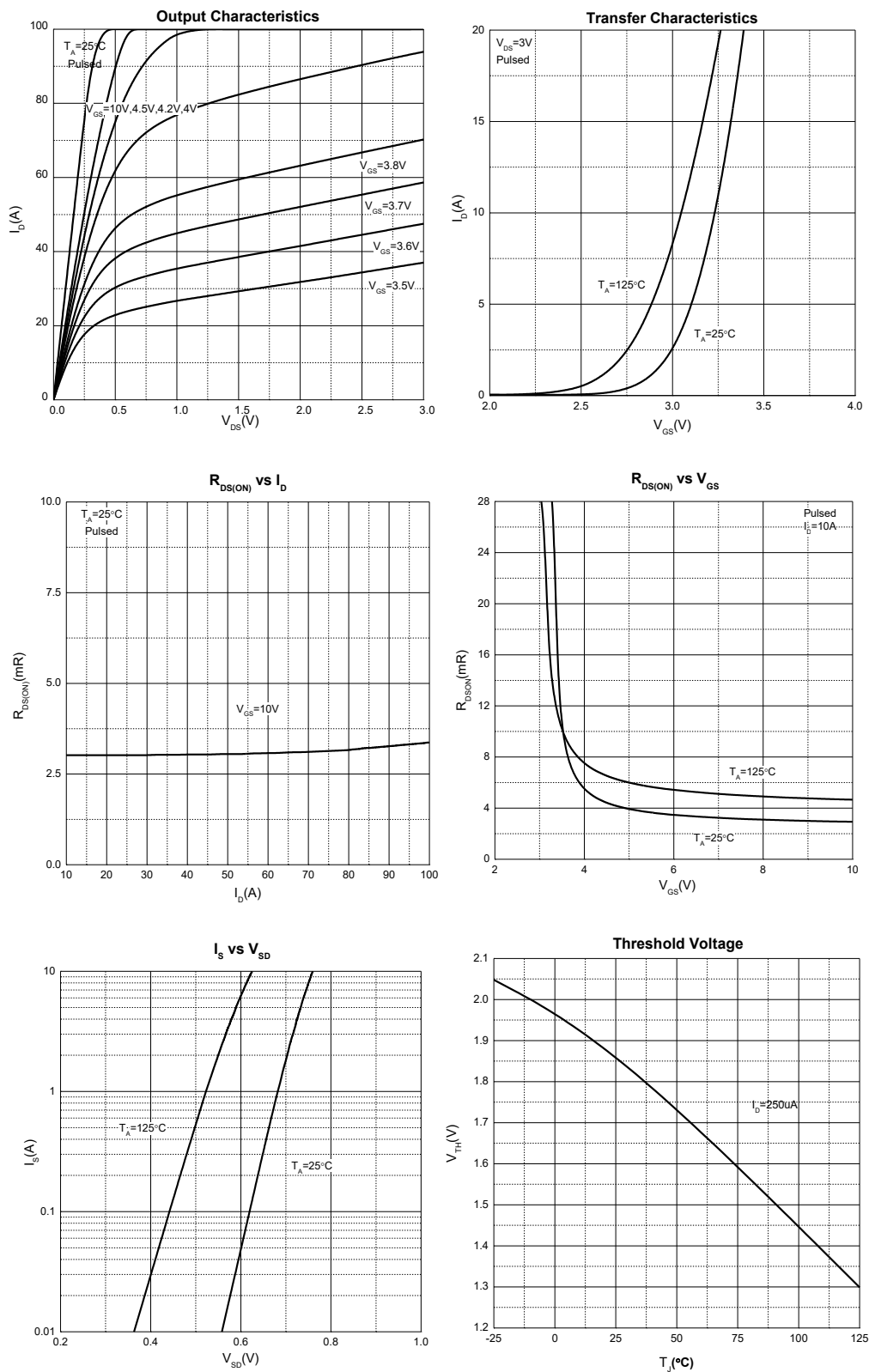
MOSFET ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

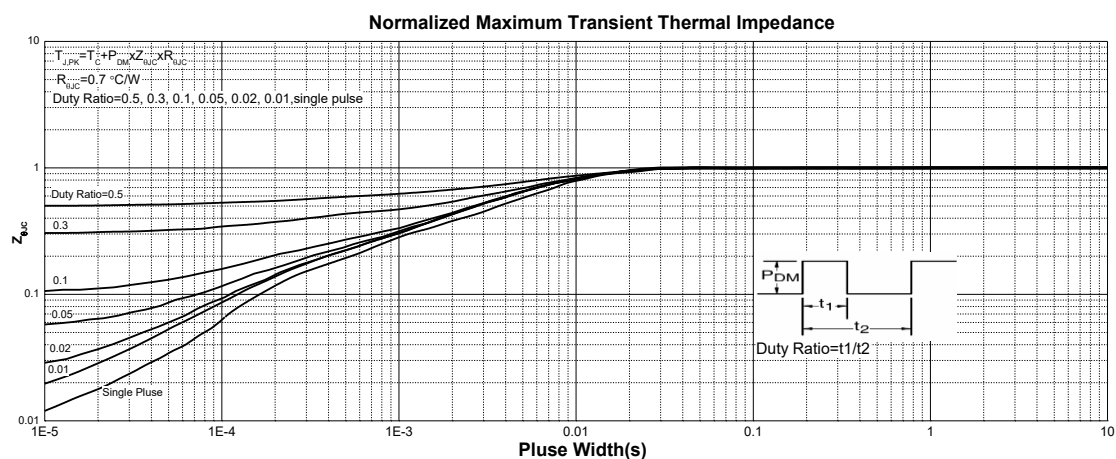
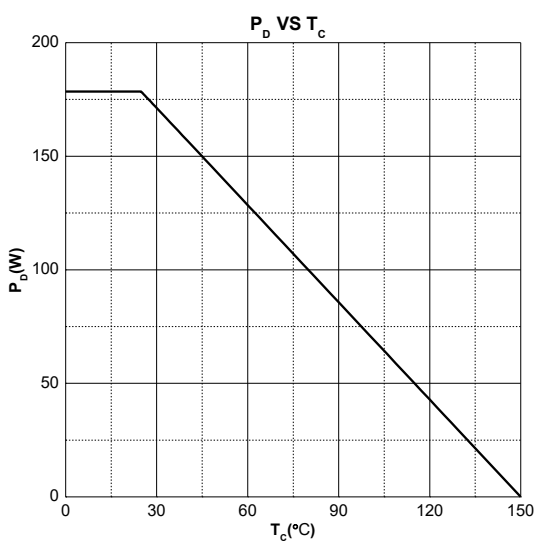
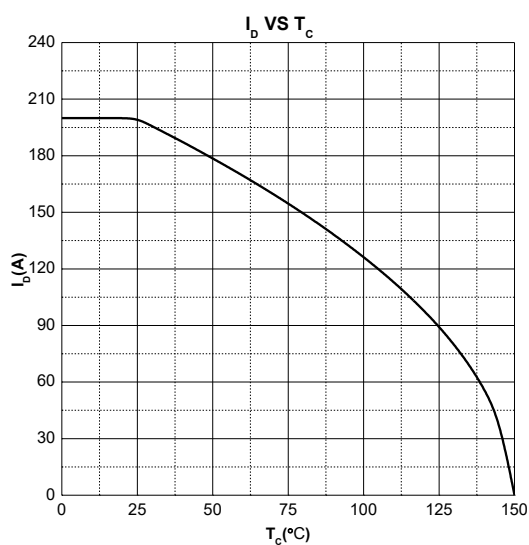
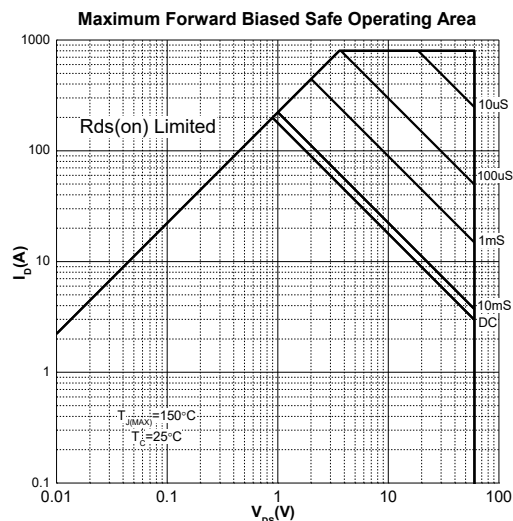
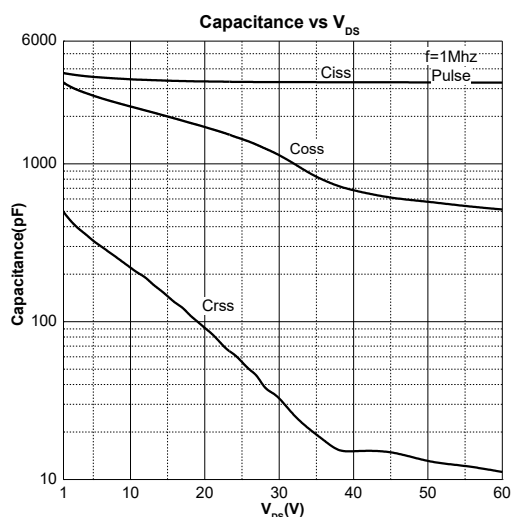
Parameter	Symbol	Test Condition	Min	Type	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250μA	60			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 60V, V _{GS} = 0V			1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} = ±20V, V _{DS} = 0V			±100	nA
On Characteristics ⁴						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250μA	1.2	1.8	2.5	V
Drain-Source On-Resistance	R _{DS(on)}	V _{GS} = 10V, I _D = 20A		2.8	3.5	mΩ
		V _{GS} = 4.5V, I _D = 15A		4.5	6.5	mΩ
Forward Transconductance	g _{FS}	V _{DS} = 5V, I _D = 20A	50			S
Dynamic Characteristics						
Input Capacitance	C _{iss}	V _{DS} = 30V, V _{GS} = 0V, f = 1MHz		3328		pF
Output Capacitance	C _{oss}			1143		
Reverse Transfer Capacitance	C _{rss}			25		
Gate Resistance	R _g	V _{DS} = 0V, V _{GS} = 0V, f = 1MHz		0.8		Ω
Switching Characteristics						
Total Gate Charge	Q _g	V _{DS} = 30V, V _{GS} = 10V, I _D = 30A		52		nC
Gate-Source Charge	Q _{gs}			10		
Gate-Drain Charge	Q _{gd}			9.3		
Gate Plateau Voltage	V _{plateau}			3.3		V
Turn-On Delay Time	t _{d(on)}	V _{DD} = 30V, V _{GS} = 10V, I _D = 20A, R _G = 3Ω		4		ns
Turn-On Rise Time	t _r			5		
Turn-Off Delay Time	t _{d(off)}			30		
Turn-Off Fall Time	t _f			15		
Source-Drain Diode Characteristics						
Diode Forward Voltage ⁴	V _{SD}	V _{GS} = 0V, I _S = 20A			1.2	V
Diode Continuous Forward Current ¹	I _S	T _C = 25℃			110	A
Diode Pulse Forward Current ²	I _{SM}	T _C = 25℃			440	A
Diode Reverse Recovery Time	t _{rr}	I _F = 20A, dI/dt = 100A/μs		38		ns
Diode Reverse Recovery Charge	Q _{rr}	I _F = 20A, dI/dt = 100A/μs		35		nC

Notes:

- 1.The maximum current rating is limited by package. And device mounted on a large heatsink.
- 2.Pulse Test: Pulse Width ≤ 10μs, duty cycle ≤ 1%.
- 3.EAS condition: V_{DD} = 30V, V_{GS} = 10V, L = 0.5mH, R_G = 25Ω Starting T_J = 25°C.
- 4.Pulse Test: Pulse Width ≤ 300μs, duty cycle ≤ 2%.
- 5.The power dissipation P_D is limited by T_{J(MAX)} = 150°C. And device mounted on a large heatsink.
- 6.Device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A = 25°C.

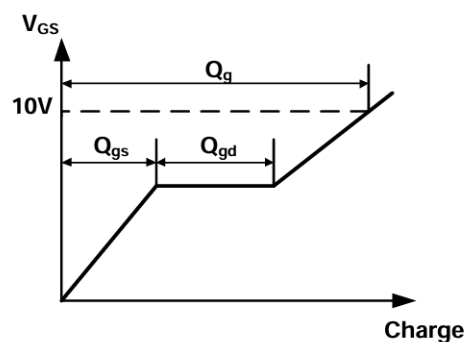
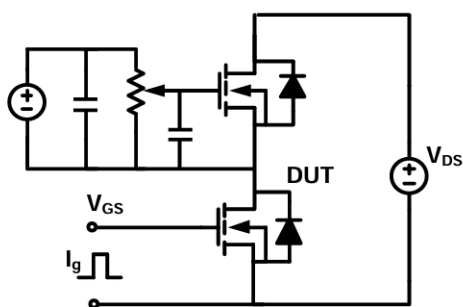
Typical Characteristics



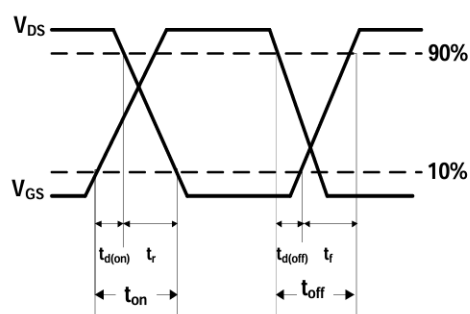
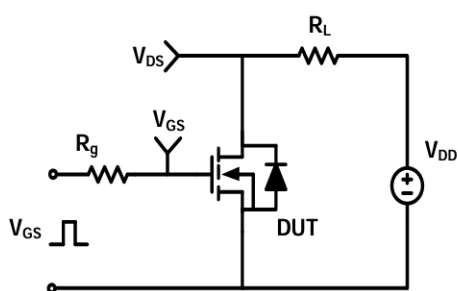


Test Circuit

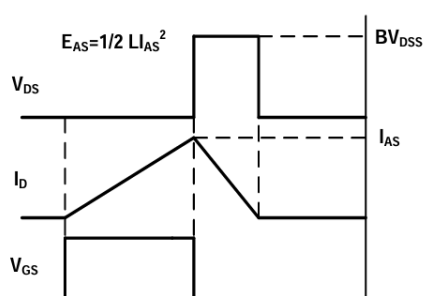
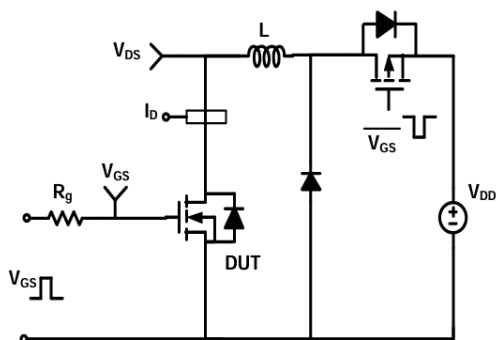
Gate Charge Test Circuit & Waveform



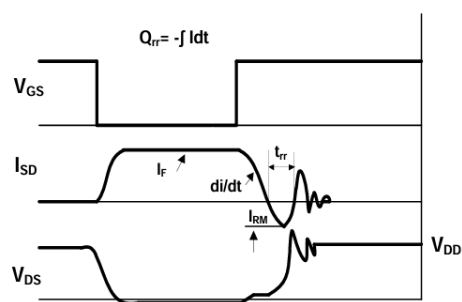
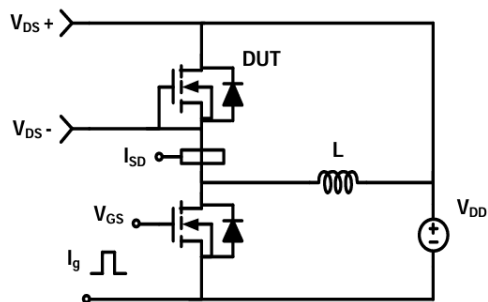
Resistive Switching Test Circuit & Waveform

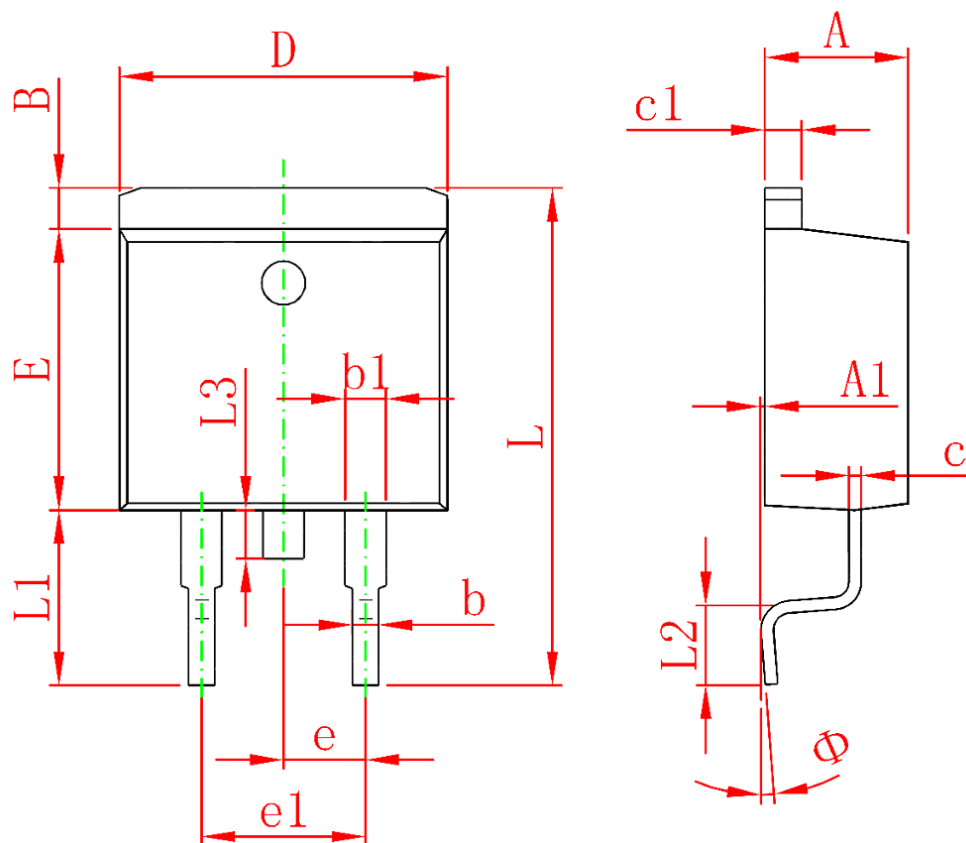


Unclamped Inductive Switching (UIS) Test Circuit & Waveform



Diode Recovery Test Circuit & Waveform



TO-263-2L Package Information


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.370	4.770	0.172	0.188
A1	0.000	0.250	0.000	0.010
B	1.070	1.470	0.042	0.058
b	0.700	0.960	0.028	0.038
b1	1.170	1.470	0.046	0.058
c	0.310	0.530	0.012	0.021
c1	1.170	1.420	0.046	0.056
D	9.860	10.360	0.388	0.408
E	8.500	8.900	0.335	0.350
e	2.540TYP		0.100TYP	
e1	4.980	5.180	0.196	0.204
L	14.700	15.500	0.579	0.610
L1	4.950	5.450	0.195	0.215
L2	2.000	2.740	0.079	0.108
L3	1.300	1.700	0.051	0.067
Φ	0°	8°	0°	8°

Attention:

- GreenPower Electronics reserves the right to improve product design function and reliability without notice.
- Any and all semiconductor products have certain probability to fail or malfunction, which may result in personal injury, death or property damage. Customer are solely responsible for providing adequate safe measures when design their systems.
- GreenPower Electronics products belong to consumer electronics or other civilian electronic products.